

L Number	Hits	Search Text	DB	Time stamp
-	162185	piezoelectric	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 09:26
-	113518	ink adj jet	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 09:26
-	101290	(liquid ink) near3 chamber	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 09:26
-	213241	plat\$3 near3 material	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 09:27
-	3	nucleus adj3 assistance adj2 material	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 09:28
-	2602	nucleus near2 material	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 09:28
-	28	(plat\$3 near3 material) same (nucleus near2 material)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 09:37
-	12	plating with nucleus with (assist\$5 growth) with electroless	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 09:49
-	5840	piezoelectric and (ink adj jet) and ((liquid ink) near3 chamber)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 09:59
-	2	(plating with nucleus with (assist\$5 growth) with electroless) and (piezoelectric and (ink adj jet) and ((liquid ink) near3 chamber))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 09:48
-	212842	diaphragm	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 09:49
-	1191	(piezoelectric and (ink adj jet) and ((liquid ink) near3 chamber)) and diaphragm	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 09:49

-	480	plating with nucleus with electroless	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 09:49
-	1	((piezoelectric and (ink adj jet) and ((liquid ink) near3 chamber)) and diaphragm) and (plating with nucleus with electroless)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 09:49
-	29347	plating with electroless	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 09:50
-	18	((piezoelectric and (ink adj jet) and ((liquid ink) near3 chamber)) and diaphragm) and (plating with electroless)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 09:50
-	1662	piezoelectric and ((liquid ink) near3 chamber) and diaphragm	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 09:59
-	18	(plating with electroless) and (piezoelectric and ((liquid ink) near3 chamber) and diaphragm)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 10:10
-	1	(plating with nucleus with electroless) same diaphragm	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 10:10
-	56	(plating with electroless) same diaphragm	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 10:11
-	51	((plating with electroless) same diaphragm) and @ay<=2002	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 10:28
-	1936	ionization near4 larg\$2	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 10:29
-	1	(plating with nucleus with electroless) same (ionization near4 larg\$2)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 10:29
-	2	ionization same (plating with nucleus with electroless)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 10:47

-	3	3664860.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 10:57
-	2	06143590.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/09 10:57